

DATASHEET

Technical Data Sheet 1.2mm round Subminiature Side Looking Infrared LED IR26-71C/L447/S63/TR8

Features

- Small double-end package
- Low forward voltage
- Good spectral matching to Si photo detector
- Package in 8mm tape on 7" diameter reel.
- Pb free
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)

Description

• IR26-71C/L447/S63/TR8 is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with spherical top view lens. The device is spectrally matched with silicon photodiode and phototransistor

Applications

• Infrared applied system

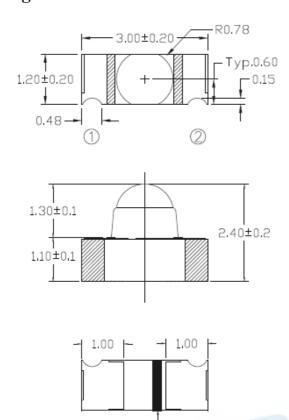
Device Selection Guide

Device No.	Chip Material	Lens Color	
IR26-71C/L447/S63/TR8	GaAlAs	Water Clear	

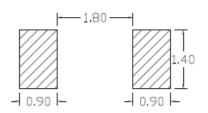




Package Dimensions



① — ② ②
① Anode
② Cathode



Recommended Soldering Pattern for Side Looker

Notes: 1.All dimensions are in millimeters 2.Tolerances unless dimensions ± 0.1 mm

Cathode Mark

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit
Continuous Forward Current	I _F	65	mA
Peak Forward Current *1	I _{FP}	400	mA
Reverse Voltage	V_{R}	5	V
Operating Temperature	T_{opr}	-40 ~ +85	℃
Storage Temperature	T _{stg}	-40 ~ +100	℃
Soldering Temperature *2	T _{sol}	260	°C
Power Dissipation at(or below) 25°C Free Air Temperature	P _c	100	mW

Notes: *1: I_{FP} Conditions--Pulse Width $\leq 10 \,\mu$ s and Duty $\leq 20\%$ @ 10K pps.

*2: Soldering time ≤ 5 seconds.



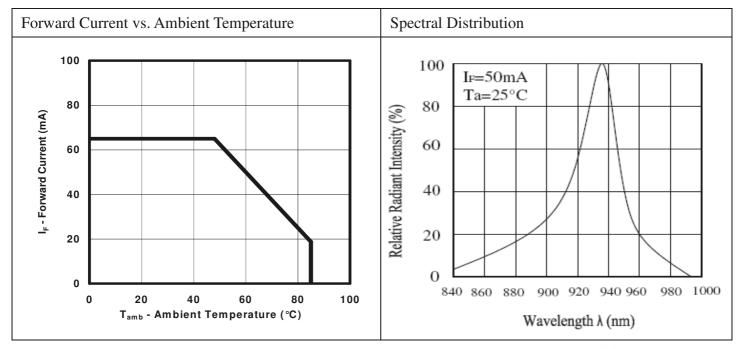
Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

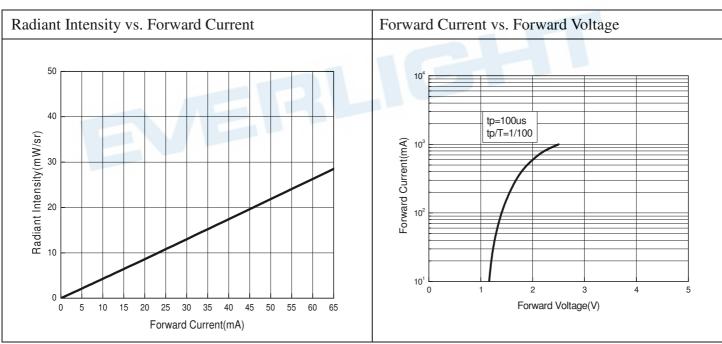
Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Radiant Intensity		5.0	8.5		mW/sr	I _F =20mA
	Ι _Ε		44		mW/sr	I _{FP} =100mA Pulse Width=10μS Duty=1%
Peak Wavelength	λp		940		nm	I _F =20mA
Spectral Bandwidth	Δλ		35		nm	I _F =20mA
Forward Voltage		1.15	1.30	1.60	V	I _F =20mA
	V _F		1.70	2.10	V	I _{FP} =100mA Pulse Width=10μS Duty=1%
Reverse Current	I _R			10	μΑ	V _R =5V
View Angle	2θ _{1/2}		50		Deg.	I _F =20mA



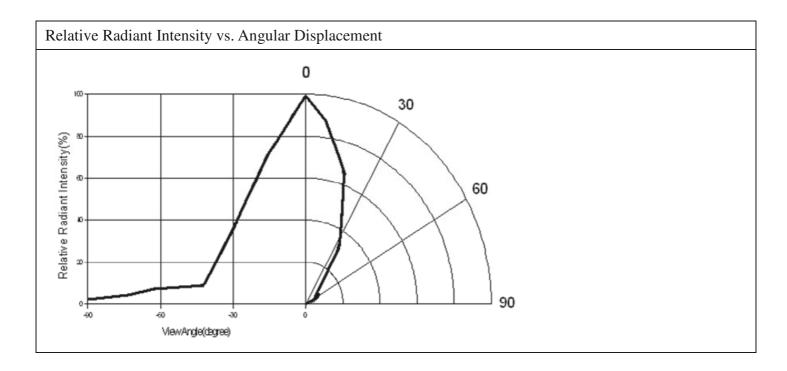


Typical Electrical/Optical/Characteristics Curves













Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

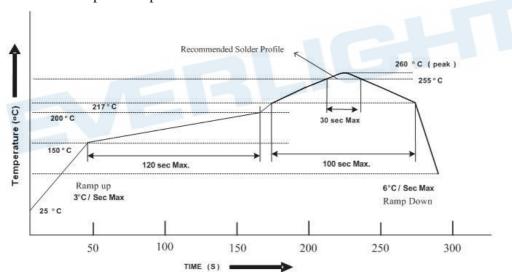
2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 60%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30° C or less and 60%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : $60\pm5^{\circ}$ C for Min. 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

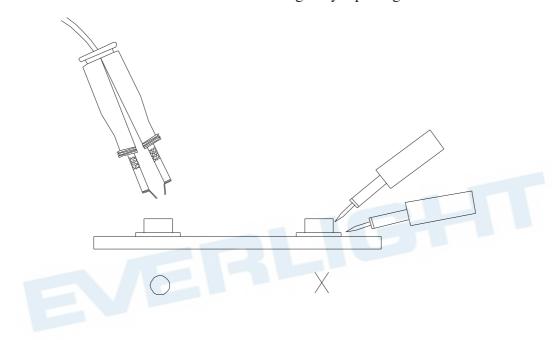


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

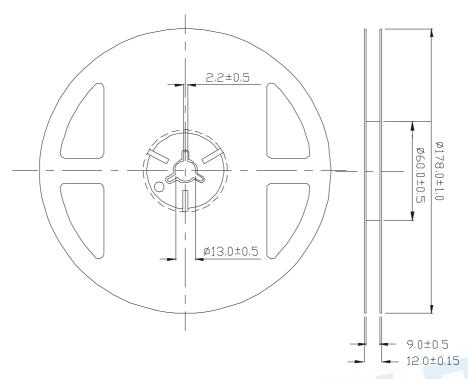
5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



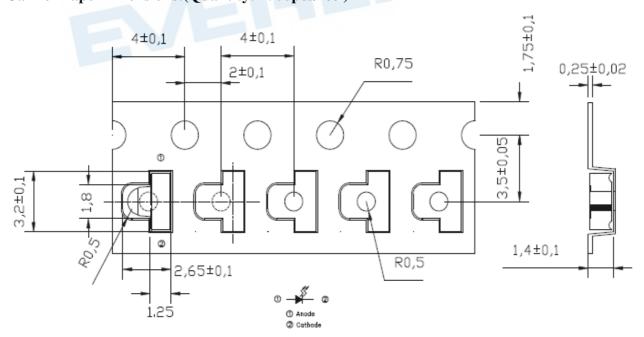


Package Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

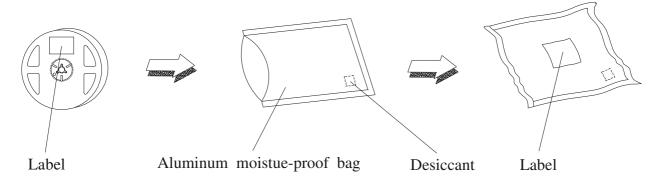
Carrier Tape Dimensions:(Quantity: 1500pcs/reel)



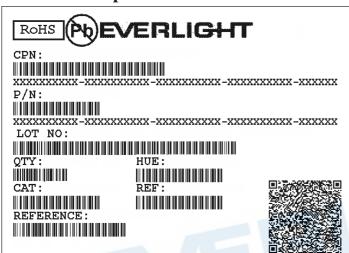
Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm



Packing Procedure



Label Form Specification



CPN: Customer's Production Number

P/N : Production Number QTY: Packing Quantity

CAT: Ranks

HUE: Peak Wavelength

REF: Reference

LOT No: Lot Number

MADE IN TAIWAN: Production Place

DISCLAIMER

- 1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- 5. These specification sheets include materials protected under copyright of EVERLIGHT. Reproduction in any form is prohibited without obtaining EVERLIGHT's prior consent.
- 6. This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or life saving applications or any other application which can result in human injury or death. Please contact authorized Everlight sales agent for special application request.

单击下面可查看定价,库存,交付和生命周期等信息

>>Everlight(亿光)